

20 V, P-channel Trench MOSFET 30 October 2015

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Trench MOSFET technology
- Very fast switching
- Enhanced power dissipation capability: Ptot = 980 mW
- ElectroStatic Discharge (ESD) protection > 2 kV HBM
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- High-side loadswitch
- Switching circuits

4. Quick reference data

Table 1. Qui	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V
V _{GS}	gate-source voltage			-12	-	12	V
I _D	drain current	V_{GS} = -4.5 V; T_{amb} = 25 °C; t ≤ 5 s	[1]	-	-	-5.3	А
Static characteristics							
R _{DSon}	drain-source on-state resistance	V _{GS} = -4.5 V; I _D = -3 A; T _j = 25 °C		-	28	34	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

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5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	3	D
2	S	source		
3	D	drain	1 2 TO-236AB (SOT23)	G G S 017aaa259

6. Ordering information

Table 3. Ordering information						
Type number						
	Name	Description	Version			
PMV30XPEA	TO-236AB	plastic surface-mounted package; 3 leads	SOT23			

7. Marking

Table 4. Marking codes	
Type number	Marking code
	[1]
PMV30XPEA	DM%

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

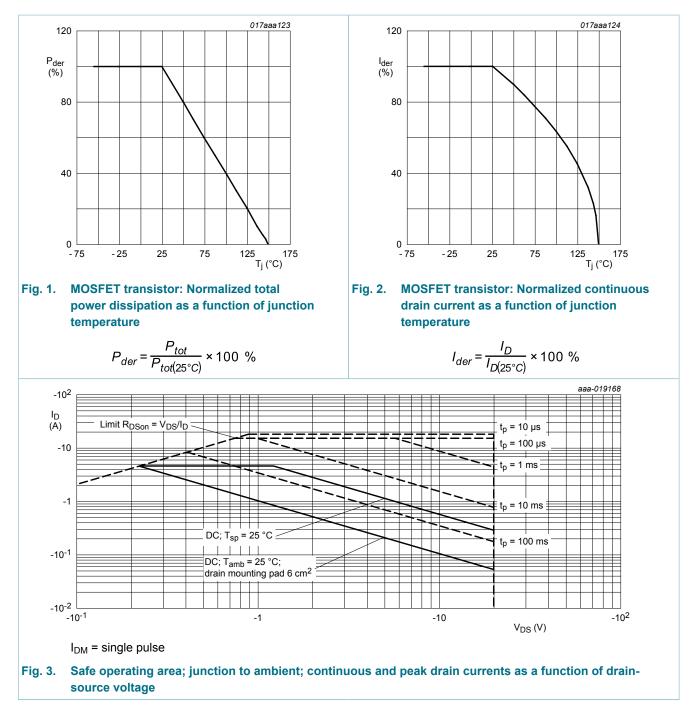
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-12	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	-5.3	А
		V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-4.5	А
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-2.8	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-18	А
E _{DS(AL)R}	repetitive drain-source avalanche energy	I_D = -1.3 A; $T_{j(init)}$ = 25 °C; DUT in avalanche (unclamped)		-	13	mJ
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	490	mW
			[1]	-	980	mW
		T _{sp} = 25 °C		-	5435	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-dra	in diode	·				
I _S	source current	T _{amb} = 25 °C	[1]	-	-0.89	А
ESD maxim	num rating	·				
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	2000	V

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.

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Thermal characteristics 9.

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to		e in free air	[1]	-	220	255	K/W
	from junction to ambient		[2]	-	110	130	K/W
	ampient	in free air; t ≤ 5 s	[2]	-	80	90	K/W
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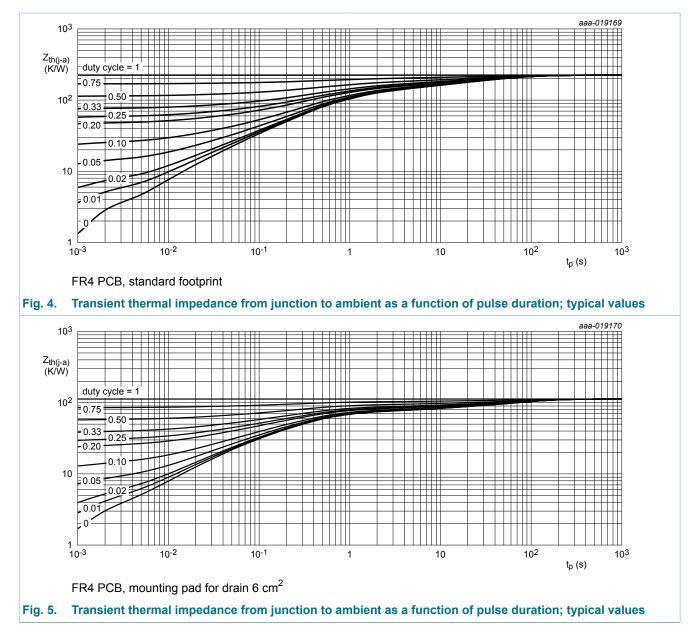
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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point		-	20	25	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².



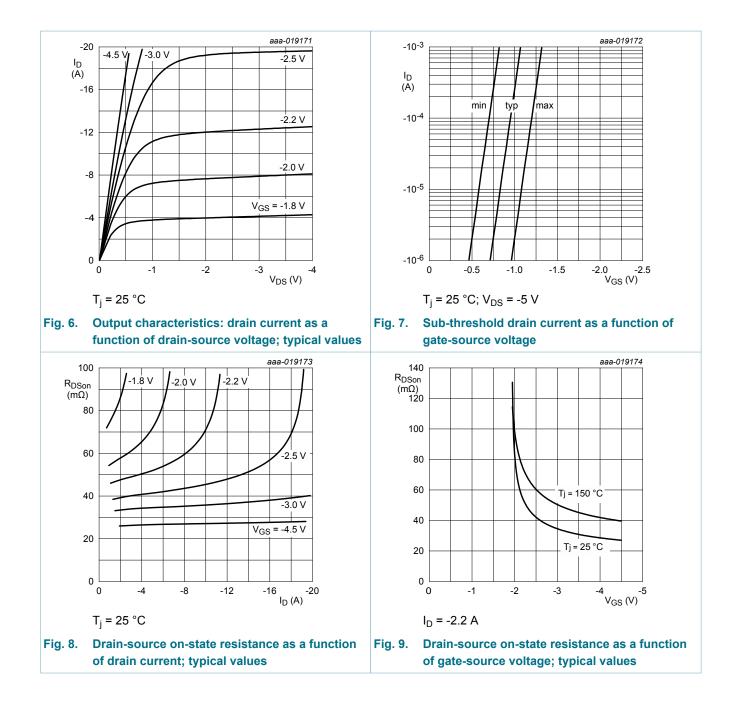
10. Characteristics

	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 µA; V_{GS} = 0 V; T_j = 25 °C	-20	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.75	5 -1	-1.25	V
I _{DSS}	drain leakage current	V_{DS} = -20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
I _{GSS}	gate leakage current	V_{GS} = 12 V; V_{DS} = 0 V; T_j = 25 °C	-	-	10	μA
		V _{GS} = -12 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-10	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	5	μA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-5	μA
		V_{GS} = 2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V _{GS} = -2.5 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-100	nA
R _{DSon}	Son drain-source on-state	V_{GS} = -4.5 V; I _D = -3 A; T _j = 25 °C	-	28	34	mΩ
resistance	resistance	V _{GS} = -4.5 V; I _D = -3 A; T _j = 150 °C	-	42	49	mΩ
		V _{GS} = -2.5 V; I _D = -3 A; T _j = 25 °C	-	42	57	mΩ
9 _{fs}	forward transconductance	V_{DS} = -10 V; I_D = -2 A; T_j = 25 °C	-	13	-	S
R _G	gate resistance	f = 1 MHz	-	10.4	-	Ω
Dynamic cl	naracteristics		1 1	1		
Q _{G(tot)}	total gate charge V_{DS} = -10 V; I_D = -3 A; V_{GS} = -4.5 V		-	11	17	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	3.2	-	nC
Q _{GD}	gate-drain charge	-	-	2	-	nC
C _{iss}	input capacitance	V _{DS} = -10 V; f = 1 MHz; V _{GS} = 0 V;	-	1465	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	193	-	pF
C _{rss}	reverse transfer capacitance		-	133	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -10 V; I _D = -3 A; V _{GS} = -4.5 V;	-	7.9	-	ns
t _r	rise time	R _{G(ext)} = 6 Ω; T _j = 25 °C	-	42	-	ns
t _{d(off)}	turn-off delay time		-	59	-	ns
t _f	fall time		-	27.5	-	ns
Source-dra	in diode	1		1	1	
V _{SD}	source-drain voltage	I _S = -0.89 A; V _{GS} = 0 V; T _i = 25 °C	_	-0.7	-1.2	V

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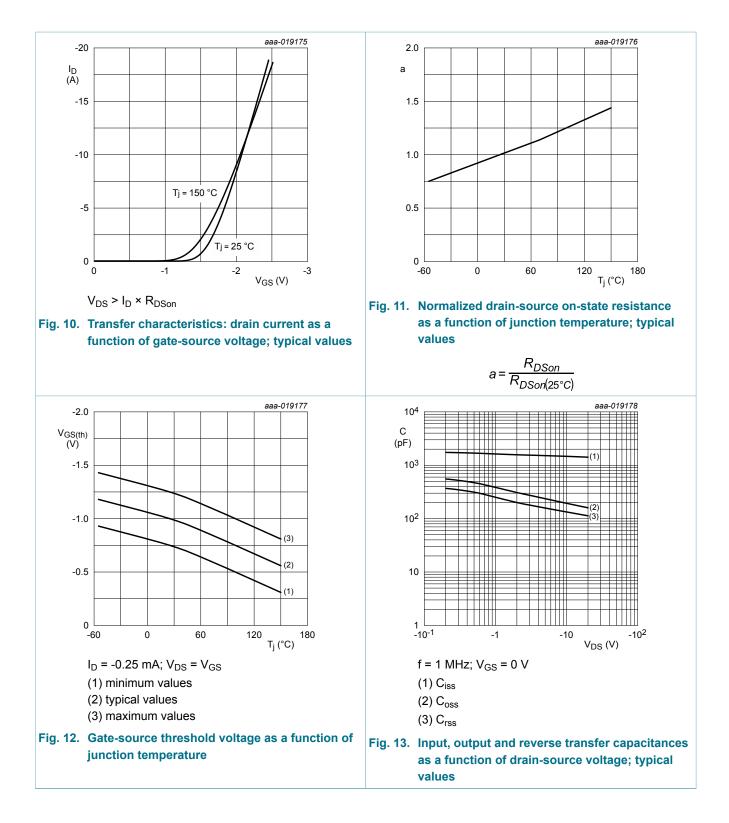
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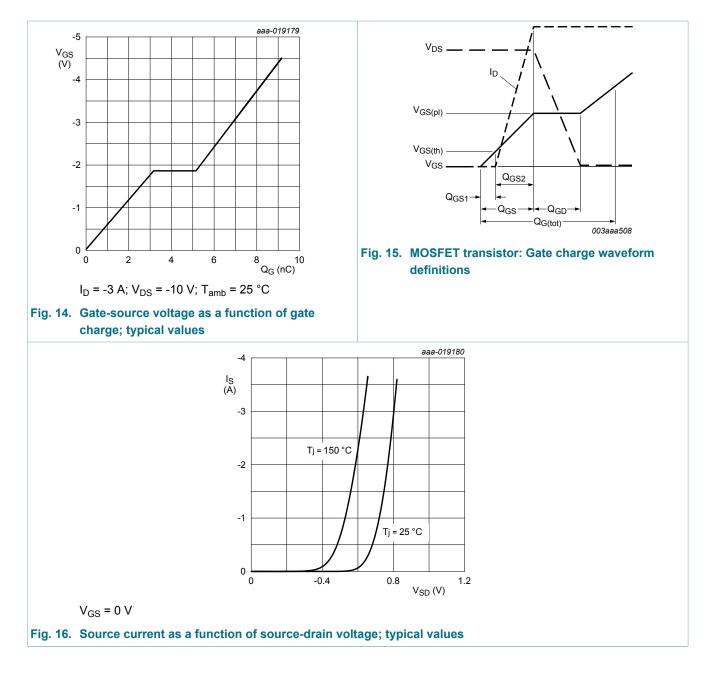
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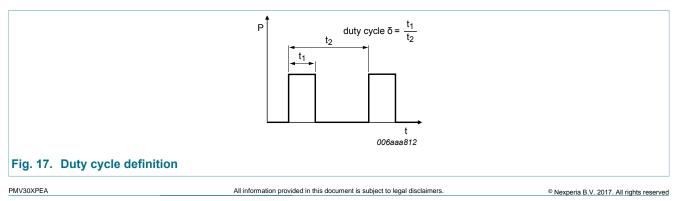
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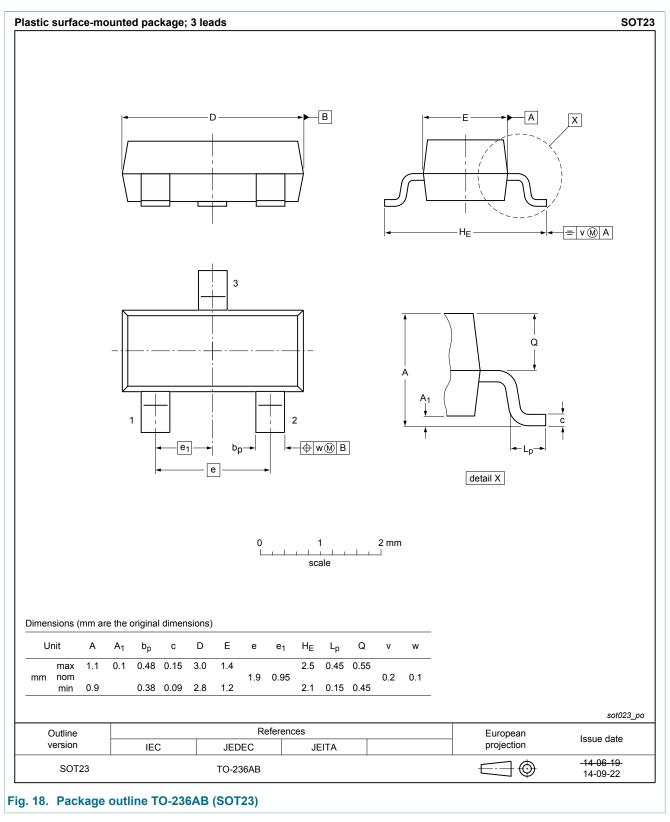
11. Test information



11.1 Quality information

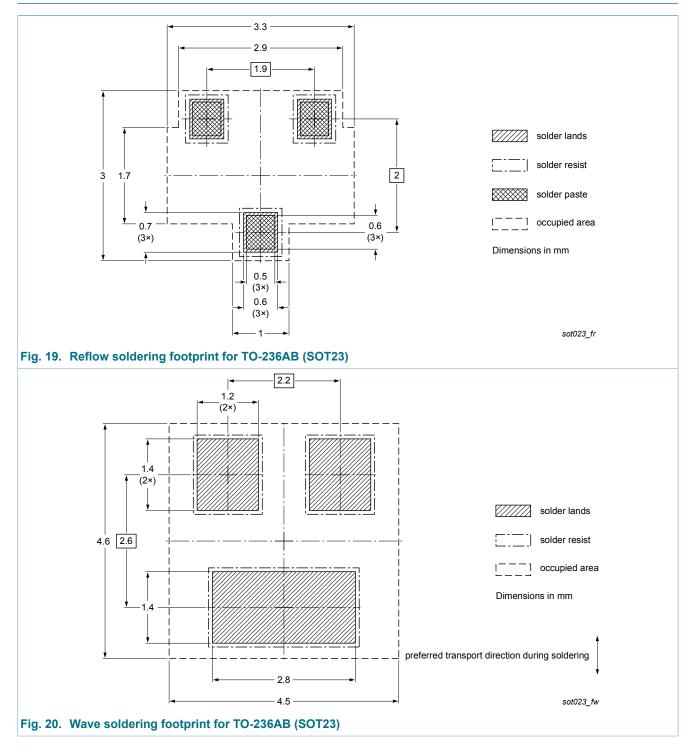
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMV30XPEA v.1	20151030	Product data sheet	-	-		

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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